

# 2:1 Switched Capacitor DC – DC Voltage Converter

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## Motivation

Recent advances in mobile electronics show explosive growth in the demand for compute power, data storage and, the number of RF and analog interfaces mandated by increasingly context-aware and perceptual user experience. These factors combined with the compact form factor demands and extreme sensitivity to cost and energy are driving innovations in mixed-signal SoCs at an unprecedented rate.

Also, conventional inductor based switched converters suffer from scalability limitations in size and power. Thus recently, switched capacitor DC-DC converters have emerged with increased current carrying capability.

## Introduction

The basic idea regarding how to design Switched Capacitor DC-DC Voltage Converter is to obtain an output in the multiples you want based on the switching pattern of the switches and the configuration of the circuit.

There are various topologies like 2:1,3:2,5:4, etc. and vice-versa are shown in Figure 1.

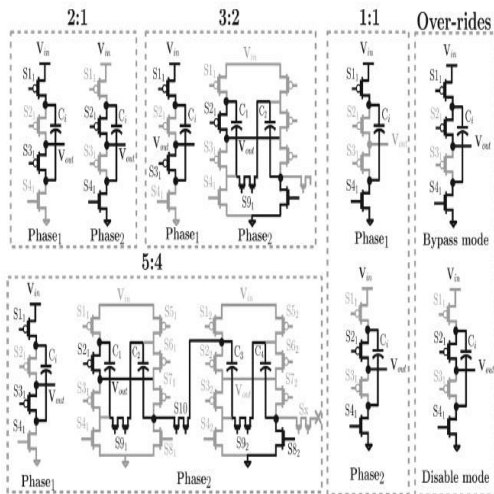


Fig. 5. Multiple transformation ratios.

Figure 1: Various Topologies

## Challenges

Fully integrated circuits in paper reviews thus it was difficult to implement all of it in such short time. Deciding as to which circuit to implement because every paper went for different approaches.

Issues with using Virtuoso, as it was the first time using virtuoso and with pdf tutorial one cannot get a total overview. And it was a huge learning curve. As of now, I can for sure design circuits using virtuoso. Pressure of completing project in virtually 2 months was immense as at first it was difficult to approach.

## Review of existing work

I went through these papers and tried to extract the main circuits and had discussion with professor as to which circuit to go for. After long chat, finalized the below circuit. The comparison for different circuit are shown in Table 1.

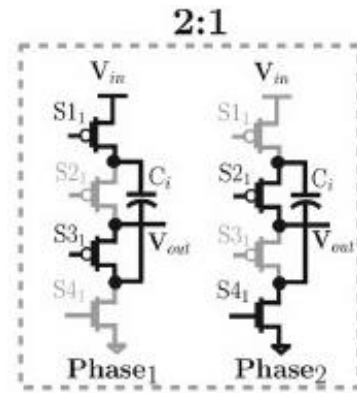


Figure 1: Various Topologies

## Analysis

I went through many circuits and went through many papers before finalizing the approach. I reviewed the results for LDO, Fully integrated VR, for single as well as multi cores. Goal at first was to design a circuit which can incorporate all the topologies, and which can switch based on the output requirement. With the current circuit we get ideal output at a load of around

1-1.1k $\Omega$ . Tried varying width of transistors, along with that varied values of capacitors and load. Also,  $V_{ph1}$  and  $V_{ph2}$  should be out of phase with each other.

The combination of Width of PMOS= 11 $\mu$ m and NMOS= 10 $\mu$ m, value of flying capacitor=1 nF and that of output capacitor = 4nF gives output of 0.574 V.

### Design Model

The model designed is a 2:1 DC-DC voltage converter.

Input voltage is provided with 1.2V and 3 PMOS and 1 NMOS transistors makes for a total of four switches

which are provided with  $V_{pulse}$  ( $V_{phase}$ ) thus making circuit work in 2 phases. During the first phase Transistors 1 and 3 works thus, charging the capacitor while in second phase transistors 2 and 4 operates thus giving the output and the ideal output of 0.6 V is obtained near load of 1-1.1k $\Omega$ . Also, there are two capacitors used in total; one acts as a flying capacitor while other as an output capacitor.

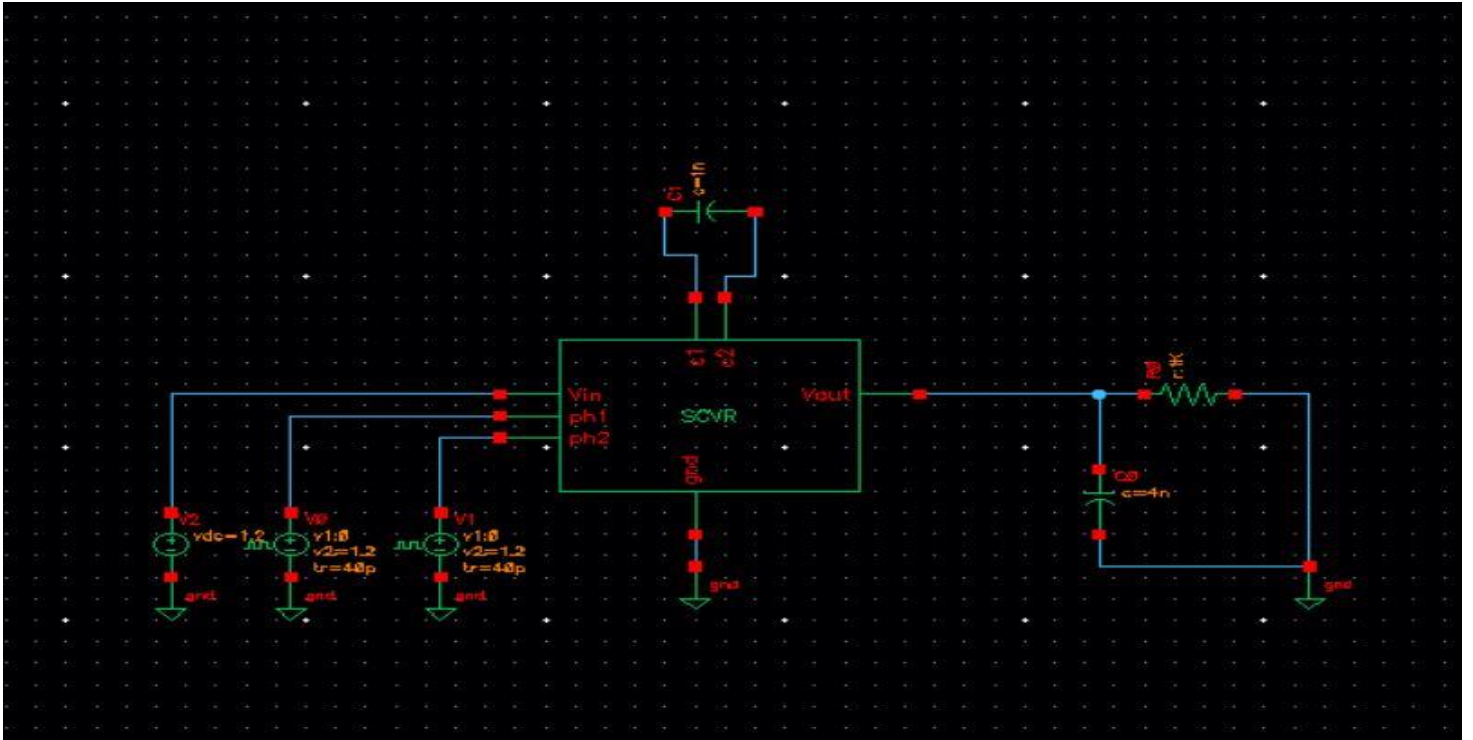


Figure 3: Circuit Diagram

### COMPARISON WITH OTHER FULLY INTEGRATED SWITCHED CAPACITOR VOLTAGE REGULATORS

| Reference                         | L. Chang<br>VLSI 2010 | Y. Ramadass<br>ISSCC 2010 | D. Somasekhar<br>VLSI 2009 | H. -P. Le<br>ISSCC 2010 | This work               |
|-----------------------------------|-----------------------|---------------------------|----------------------------|-------------------------|-------------------------|
| Process                           | 45nm SOI              | 45nm                      | 32nm                       | 32nm SOI                | 22nm trigate            |
| Passives type                     | Deep trench           | Gate Oxide SOI            | Metal Finger               | Gate Oxide              | MIM                     |
| Maximum frequency                 | 100MHz                | 30MHz                     | 1GHz                       | 225MHz                  | 250MHz                  |
| Input Voltage                     | 2V                    | 1.8V                      | 1-1.2V                     | 2V                      | 1.23V                   |
| Output                            | 0.95V/2.7mA           | 0.8-1V/8mA                | 1.5V/5mA                   | 0.4-1.1V/0.28A          | 0.45-1V, 88mA           |
| Power Efficiency %                | 90                    | 69                        | 60                         | 81                      | 70@0.55V, 84@1.1V       |
| Response time                     | Unregulated           | 120-200ns                 | Unregulated                | Unregulated             | 3-5ns <sup>†</sup>      |
| Droop                             | -                     | 250mV                     | -                          | -                       | $\ll$ 25mV <sup>†</sup> |
| Current density A/mm <sup>2</sup> | 2.3                   | 0.050                     | 1.12                       | 0.73                    | 0.88                    |
| Area Overhead                     | 13%                   | 6x                        | 26%                        | 41%                     | 3.6%                    |

†

Table 1: Comparison

## Results and Layout

This section shows the layout of the regulator along with the output waveform. Figure 4 shows the transient response. Figure 5 shows the transient response along with DC output. Figure 6 shows the regulator design used in the circuit implemented. Figure 7 shows the layout of the circuit.

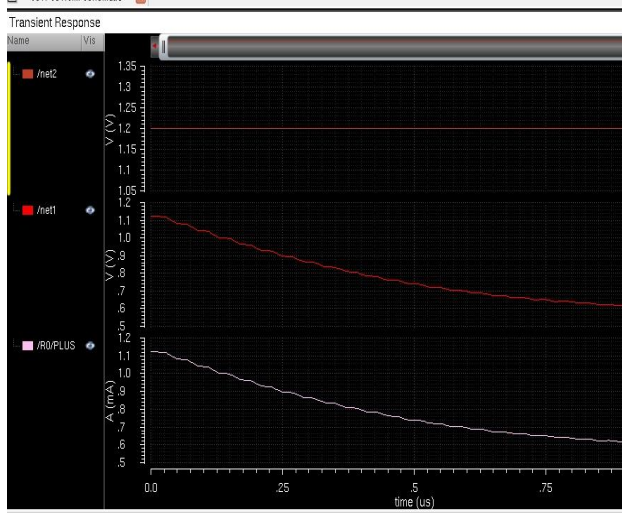


Figure 4: Transient Response

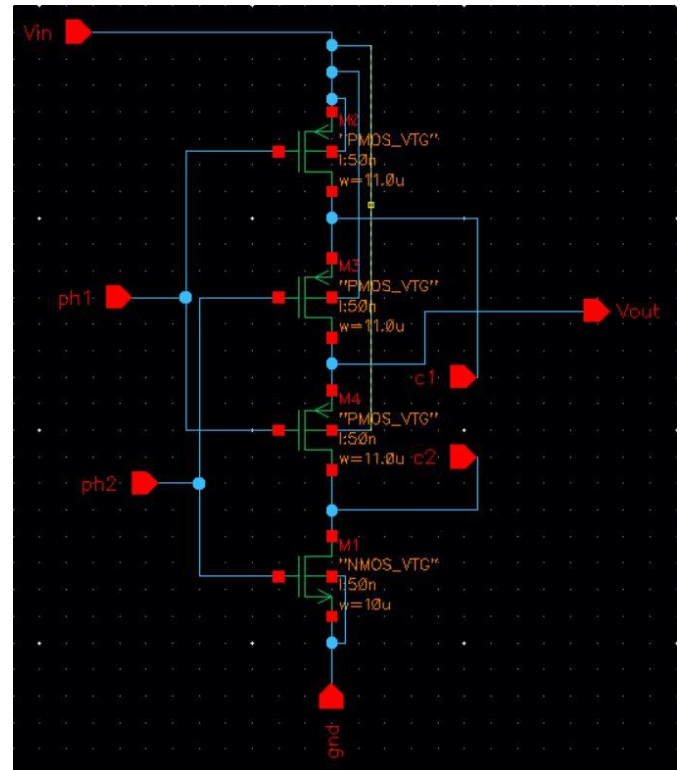


Figure 6: Regulator Design

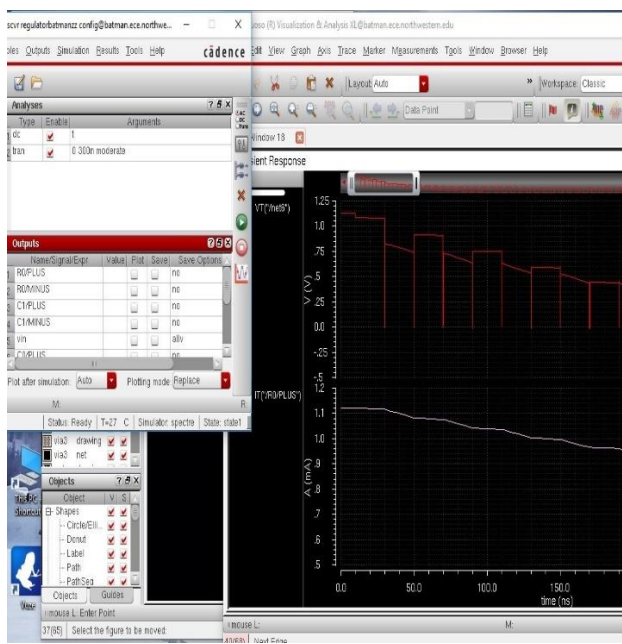


Figure 5: Output Waveform

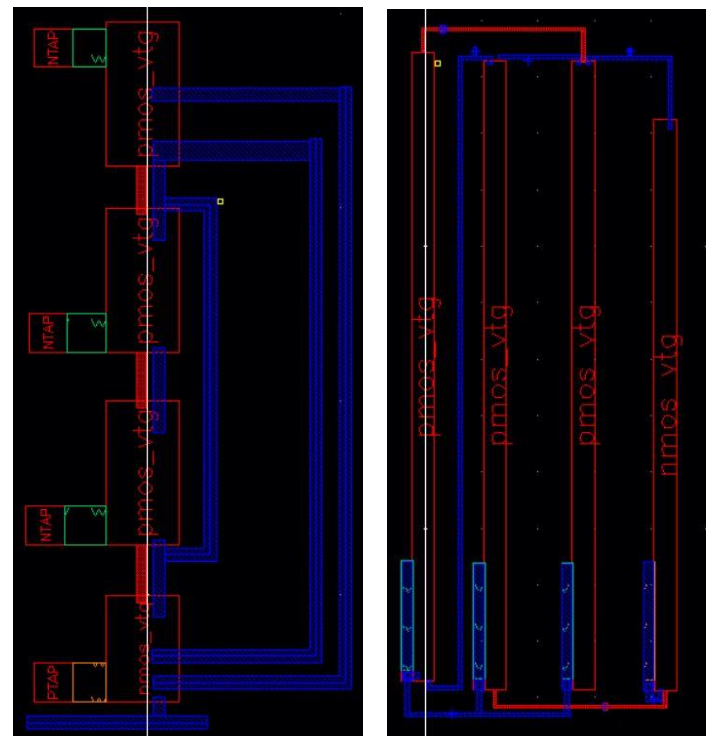


Figure 7: Layout

## **Conclusion**

The simulation result of the output is about 0.47V. Using the similar technique, we can design converters for other configurations as well. Varying the values of capacitors, transistors, load, and  $V_{\text{pulse}}$  we can optimize the output. Feedback is the main part of a regulator. But couldn't incorporate because of the time constraint. We can tune the resistor and capacitor to obtain a better output value.

## **Acknowledgment**

I would like to thank Prof. Jie Gu for his constant support and motivation. I would also like to thank the EECS 495 class, EECS department and Northwestern University for their encouragement and support.

## **References**

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